

#### 2.0x1.25mm SMD CHIP LED LAMP

KP-2012EC

HIGH EFFICIENCY RED

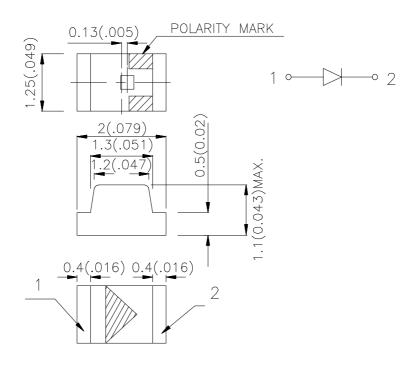
#### **Features**

- •2.0mmx1.25mm SMT LED,1.1mm THICKNESS.
- •LOW POWER CONSUMPTION.
- •WIDE VIEWING ANGLE.
- •IDEAL FOR BACKLIGHT AND INDICATOR.
- •VARIOUS COLORS AND LENS TYPES AVAILABLE.
- •PACKAGE: 2000PCS/REEL.
- •RoHS COMPLIANT.

#### **Description**

The High Efficiency Red source color devices are made with Gallium Arsenide Phosphide on Gallium Phosphide Orange Light Emitting Diode.

### **Package Dimensions**



#### Notes

- All dimensions are in millimeters (inches).
- 2. Tolerance is  $\pm 0.1(0.004")$  unless otherwise noted.
- Specifications are subject to change without notice.

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#### **Selection Guide**

Part No.	Dice	Lens Type	Iv (mcd) @ 20mA		Viewing Angle
		-	Min.	Тур.	2 θ 1/2
KP-2012EC	HIGH EFFICIENCY RED (GaAsP/GaP)	WATER CLEAR	4	12	120°

Note:

### Electrical / Optical Characteristics at Ta=25°C

Symbol	Parameter	Device	Тур.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	High Efficiency Red	627		nm	IF=20mA
λD	Dominant Wavelength	High Efficiency Red	625		nm	IF=20mA
Δλ1/2	Spectral Line Half-width	High Efficiency Red	45		nm	IF=20mA
С	Capacitance	High Efficiency Red	15		pF	VF=0V;f=1MHz
VF	Forward Voltage	High Efficiency Red	2.0	2.5	V	IF=20mA
lr	Reverse Current	High Efficiency Red		10	uA	VR = 5V

### Absolute Maximum Ratings at TA=25°C

Parameter	High Efficiency Red	Units
Power dissipation	105	mW
DC Forward Current	30	mA
Peak Forward Current [1]	160	mA
Reverse Voltage	5	V
Operating/Storage Temperature	-40°C To +85°C	

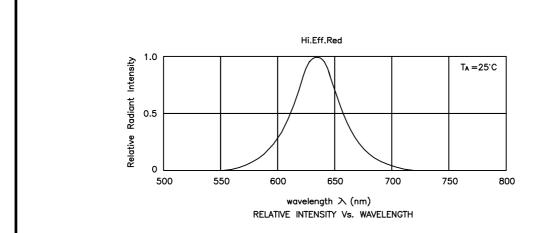
Note

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<sup>1.</sup>  $\theta$ 1/2 is the angle from optical centerline where the luminous intensity is 1/2 the optical centerline value.

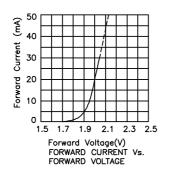
<sup>1. 1/10</sup> Duty Cycle, 0.1ms Pulse Width.

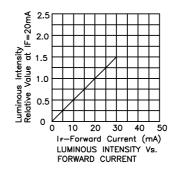
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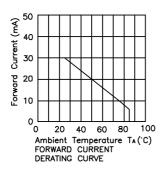


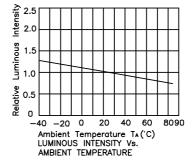
**High Efficiency Red** 

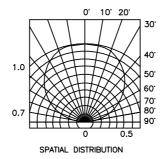
**KP-2012EC** 











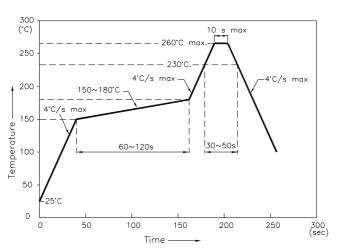
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#### **KP-2012EC**

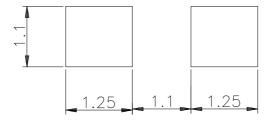
Reflow Soldering Profile For Lead-free SMT Process.



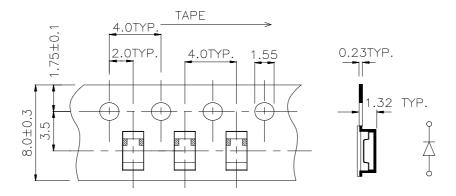
NOTES:

- 1.We recommend the reflow temperature 245°C(+/-5°C).The maximum soldering temperature should be limited to 260°C.
- 2.Don't cause stress to the epoxy resin while it is exposed to high temperature.
- 3. Number of reflow process shall be 2 times or less.

## Recommended Soldering Pattern (Units: mm)



## Tape Specifications (Units: mm)



#### Remarks:

If special sorting is required (e.g. binning based on forward voltage, luminous intensity, or wavelength), the typical accuracy of the sorting process is as follows:

- 1. Wavelength: +/-1nm
- 2. Luminous Intensity: +/-15%
- 3. Forward Voltage: +/-0.1V

Note: Accuracy may depend on the sorting parameters.

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